

July 2014

FDZ1416NZ

Common Drain N-Channel 2.5 V PowerTrench® WL-CSP MOSFET

24 V, 7 A, 23 mΩ

Features

- Max $r_{S1S2(on)} = 23 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_{S1S2} = 1 \text{ A}$
- Max $r_{S1S2(on)} = 25 \text{ m}\Omega$ at $V_{GS} = 4 \text{ V}$, $I_{S1S2} = 1 \text{ A}$
- Max $r_{S1S2(on)}$ = 28 m Ω at V_{GS} = 3.1 V, I_{S1S2} = 1 A
- Max $r_{S1S2(on)} = 33 \text{ m}\Omega$ at $V_{GS} = 2.5 \text{ V}$, $I_{S1S2} = 1 \text{ A}$
- Occupies only 2.2 mm² of PCB area
- Ultra-thin package: less than 0.35 mm height when mounted to PCB
- High power and current handling capability
- HBM ESD protection level > 3.2 kV (Note 3)
- RoHS Compliant

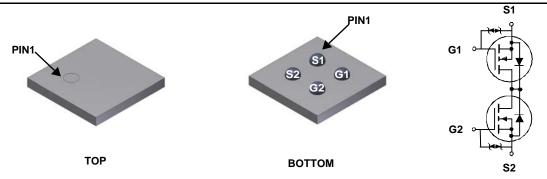


General Description

This device is designed specifically as a single package solution for Li-lon battery pack protection circuit and other ultra-portable applications. It features two common drain N-channel MOSFETs, which enables bidirectional current flow, on Fairchild's advanced PowerTrench® process with state of the art "low pitch" WLCSP packaging process, the FDZ1416NZ minimizes both PCB space and $r_{\rm S1S2(on)}.$ This advanced WLCSP MOSFET embodies a breakthrough in packaging technology which enables the device to combine excellent thermal transfer characteristics, ultra-low profile packaging, low gate charge and low $r_{\rm S1S2(on)}.$

Applications

- Battery management
- Load switch
- Battery protection



WL-CSP 1.4X1.6

MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{S1S2}	Source1 to Source2 Voltage			24	V
V _{GS}	Gate to Source Voltage		±12	V	
1	Source1 to Source2 Current -Continuous	T _A = 25°C	(Note 1a)	7	۸
IS1S2	-Pulsed			30	_ A
D	Power Dissipation	T _A = 25°C	(Note 1a)	1.7	W
P_{D}	Power Dissipation	T _A = 25°C	(Note 1b)	0.5	VV
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	74	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	230	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
EN	FDZ1416NZ	WL-CSP 1.4X1.6	7 "	8 mm	5000 units

Electrical Characteristics T_J = 25 °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	Off Characteristics					
I _{S1S2}	Zero Gate Voltage Source1 to Source2 Current	V _{S1S2} = 19 V, V _{GS} = 0 V			1	μА
I_{GSS}	Gate to Source Leakage Current	V _{GS} = ±12 V, V _{S1S2} = 0 V			±10	μΑ

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{S1S2}, I_{S1S2} = 250 \mu A$	0.4	0.9	1.3	V
\	V _{GS} = 4.5 V, I _{S1S2} = 1 A	9	16	23		
		V _{GS} = 4 V, I _{S1S2} = 1 A	10	17	25	
r _{S1S2(on)}	0.102(011)	V _{GS} = 3.1 V, I _{S1S2} = 1 A	11	19	28	mΩ
		V _{GS} = 2.5 V, I _{S1S2} = 1 A	12	22	33	
		V _{GS} = 4.5 V, I _{S1S2} = 1 A,T _J = 125 °C		24	36	
9 _{FS}	Forward Transconductance	V _{S1S2} = 5 V, I _{S1S2} = 1 A		4.5		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 42.V. V 0.V	1140	1515	pF
C _{oss}	Output Capacitance	V _{S1S2} = 12 V, V _{GS} = 0 V, f = 1 MHz	136	220	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1 101112	129	205	pF

Switching Characteristics

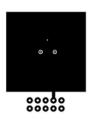
t _{d(on)}	Turn-On Delay Time		9.5	19	ns
t _r	Rise Time	V _{S1S2} = 12 V, I _{S1S2} = 1 A,	12	22	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$	37	59	ns
t _f	Fall Time		16	33	ns
Q_q	Total Gate Charge		12	17	nC
Q_{gs}	Gate to Source1 Gate Charge	$V_{S1S2} = 12 \text{ V, } I_{S1S2} = 1 \text{ A,}$ $V_{G1S1} = 4.5 \text{ V, } V_{G2S2} = 0 \text{ V}$	1.6		nC
Q_{gd}	Gate to Source2 "Miller" Charge	VG1S1 = 4.5 V, VG2S2 = 0 V	3.7		nC

Source1 to Source2 Diode Characteristics

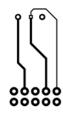
I _{fss}	Maximum Continuous Source1 to Source2 Diode Forward Current			1	Α	
V	Source1 to Source2 Diode Forward	$V_{G1S1} = 0 V, V_{G2S2} =$	4.5 V,	0.7	1.0	W
V _{fss}	Voltage	$I_{fss} = 1 A$	(Note 2)	0.7	1.2	V

Notes:

^{1.} R_{0,IA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,IC} is guaranteed by design while R_{0,CA} is determined by the user's board design.



a. 74 °C/W when mounted on a 1 in² pad of 2 oz copper



b. 230 °C/W when mounted on a minimum pad of 2 oz copper

- 2. Pulse Test: Pulse Width < 300 us, Duty cycle < 2.0%.
- 3. The diode connected between the gate and source serves only protection against ESD. No gate overvoltage rating is implied.

Typical Characteristics T_J = 25°C unless otherwise noted

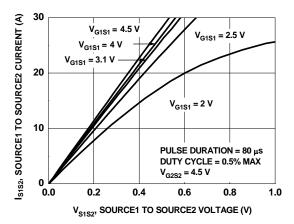


Figure 1. On-Region Characteristics

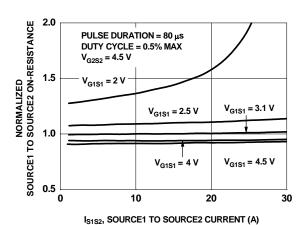


Figure 3. Normalized On-Resistance vs Source1 to Source2 Current and Gate Voltage

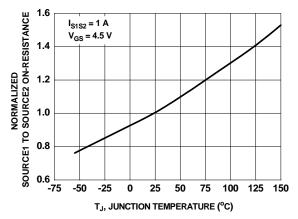
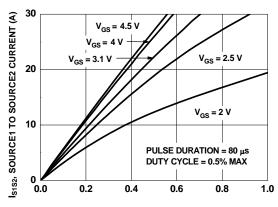


Figure 5. Normalized On Resistance vs Junction Temperature



 $V_{\rm S1S2}$, SOURCE1 TO SOURCE2 VOLTAGE (V)

Figure 2. On-Region Characteristics

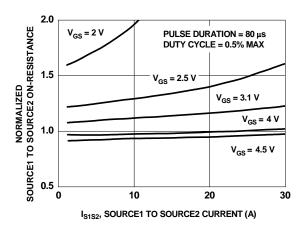


Figure 4. Normalized On-Resistance vs Source1 to Source2 Current and Gate Voltage

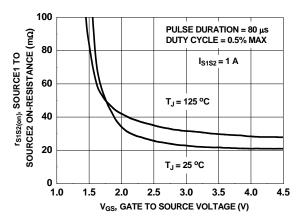


Figure 6. On Resistance vs Gate to Source Voltage

Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

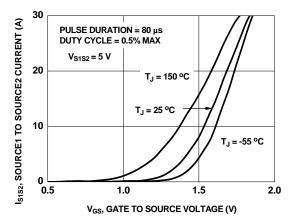


Figure 7. Transfer Characteristics

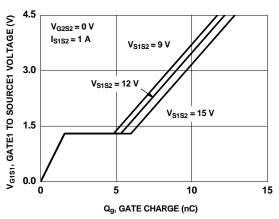


Figure 9. Gate Charge Characteristics

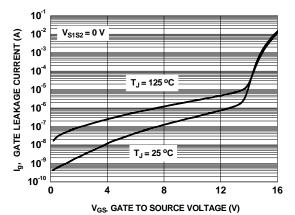
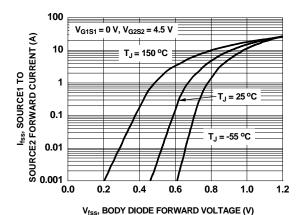
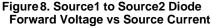


Figure 11. Gate Leakage Current vs Gate to Source Voltage



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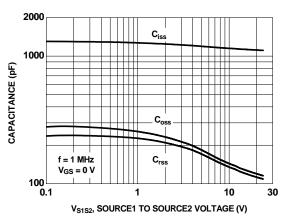
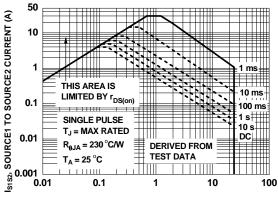


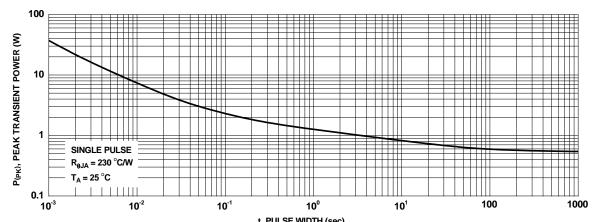
Figure 10. Capacitance vs Source1 to Source2 Voltage



V_{S1S2}, SOURCE1 TO SOURCE2 VOLTAGE (V)

Figure 12. Forward Bias Safe Operating Area





t, PULSE WIDTH (sec)
Figure 13. Single Pulse Maximum Power Dissipation

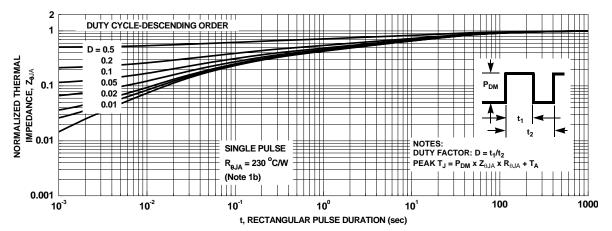
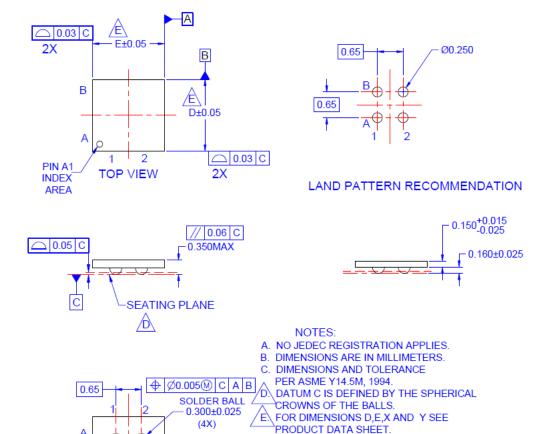


Figure 14. Junction-to-Ambient Transient Thermal Response Curve

Dimensional Outline and Pad Layout



BOTTOM VIEW

Pin Definitions:

G1	G2	S1	S2
A2	B2	A1	B1

FOR PIN-OUT ASSIGNMENT, REFER TO DATA SHEET.

G. DRAWING NAME: MKT-UC004AJREV2.

Product Specific Dimensions:

0.65

D	Е	X	Y
1.4 mm	1.6 mm	0.37 mm	0.47 mm

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